

# T-P INS 3 A0/A1 – Electrically Insulating Interface Material with High Thermal Performance

## DATASHEET



### **FEATURES**

- High tensile strength, designed to prevent cut through and electrical shorts
- Low Thermal Impedance
- UL94-V0 recognised
- No viscosity, 0.30mm thick
- Adhesive option available (A1)

#### **APPLICATIONS**

SMPS, Telecom Devices, Visual Devices, Networking Products,
LCD-TV, Notebook PC's, PC's, ME, Household Applications etc.

PROPERTIES	TEST METHOD	UNIT	T-P INS 3 A0/A1
Colour	-	-	White
Carrier	-	-	Fiberglass
Thickness (±10%)	ASTM-D374	mm	0.30
Thermal Impedance	ASTM-D5470	°C in²/W	0.16
Specific Gravity (±0.2)	ASTM-D792	g/cm <sup>3</sup>	2.77
Thermal Conductivity	ASTM-D5470	W/mK	3.0
Volume Resistance	ASTM-D257	Ohm-cm	10 <sup>11</sup>
Breakdown Voltage	ASTM-D149	kV/AC	≥4
Dielectric Constant (1Ghz)	ASTM-D150	Vac	7.0
Tensile Strength	ASTM-D412	MPa	≥1.0
Hardness (±10)	ASTM-D2240	Shore A	90
Flammability Rating	UL94 IEC 60695-11-10	-	UL94-V0
Working Temperature	EN344	°C	-40 to 200

### Note:

- Customised shapes are available;
- The above performance data is tested in an environment of 70% humidity, temperature 25°C.
- This data is intended for reference purposes only. It is recommended that the material is tested to fully evaluate its performance ensuring it is fit for purpose.
- 4. Use of an adhesive (A1) may affect thermal conductivity stated above.

Ventec International Group